IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| Application Serial No | 393 |
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| Sonfirmation No | 911 |
| Filing Date June 19, 20 | 001 |
| Inventor Richard Holscher e | t al. |
| Assignee Micron Technology, | Inc. |
| Group Art Unit | 756 |
| Examiner Unknown | own |
| Attorney's Docket No | 694 |
| Customer No | 567 |
| Title: Semiconductor Processing Methods | |

INFORMATION DISCLOSURE STATEMENT

References -- See Attached Form PTO-1449

The attached Form PTO-1449 is submitted in compliance with 37 CFR §1.56. No admission is made regarding whether the submitted references are prior art.

This Information Disclosure Statement is being filed within three months of the filing of the application or before the mailing of a first Office Action on the merits, whichever occurs last. Therefore, no fee is believed to be required. However, in the event that a fee is required for filing this Information Disclosure Statement, please charge the fee specified under 37 C.F.R. Section 1.17(p) to Deposit Account No. 23-0925. Please credit Deposit Account No. 23-0925 with any overpayment of the above fee.

Respectfully submitted,

ated: _///3/54____

Attorney:

Robert C. Hyta Reg. No. 46,791

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| FOID PROTITION | | | | PARTMENT OF COMMERCE AND TRADEMARK OFFICE | ATTY. DOCKET NO M122-1694 | | SERIAL NO. 09/885,393 | | | | |
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| Sen . | | | | | FILING DATE June 19, 2001 | | GRO 1756 | | | | |
| TRADE | MARHON | | | U.S. PATENT DOCUMENTS | | | | | | | |
| *Examiner Initial | | Document Number | Date | Name | | Class | Subclass | Filing If Appro | | | |
| | AA | 6,518,122 | 02/03 | Chan, et al. | | | | | | | |
| | AB | 6,492,688 | 12/02 | Ilg (ILG) | | | | | | | |
| | AC | 6,373,114 | 04/02 | Jeng, et al. | | | | | | | |
| | AD | 2001/0019868 | 09/01 | Gonzalez, et al. | | | | | | | |
| | AE | 6,503,818 B1 | 01/03 | Jang | | | | | | | |
| | AF | 6,486,061 B1 | 11/02 | Xia, et al. | | | | | | | |
| | AG | 6,486,057 B1 | 11/02 | Yeh, et al. | | | | | | | |
| | АН | 6,465,372 B1 | 10/02 | Xia, et al. | | | | | | | |
| | AI | 6,444,593 B1 | 09/02 | Ngo, et al. | | | | | | | |
| | AJ | 6,436,808 B1 | 08/02 | Ngo, et al. | | | | | | | |
| | AK | 6,435,943 B1 | 08/02 | Chang, et al. | | | | | | | |
| | AL | 6,429,115 B1 | 08/02 | Tsai, et al. | | | | | | | |
| | AM | 6,284,677 B1 | 09/01 | Hsiao, et al. | | | | | | | |
| | AN | 6,030,901 | 02/00 | Hopper, et al. | | | | | | | |
| | T | ¥ | | FOREIGN PATENT DOCUMEN | ITS | | | | | | |
| | | Document Date Number | | Country | | Class | Subclass | | Translation Yes No | | |
| | AM | 8046186 | 02/96 | JP | | | | 165 | _140 | | |
| | AN | 8046188 | 02/96 | JP | | | | | | | |
| | AO | 7201716 | 08/95 | JP | | | | | | | |
| | AP | 6232113 O | 08/94 THER REFEREN | JP CES (including Author, Title, Date | e, Pertinent Pages, Etc.) | | | | | | |
| | AR | | | | | | | | | | |
| | AR Wolf, S., "Silicon Processing for the VLSI Era," Vol. 1, pps. 407-413. | | | | | | | | | | |
| | AS | Wolf. S. "Silicon Processing for the VLSI Era". Vol. 2, pgs. 48-49 and 435. | | | | | | | | | |
| | | | | | | | | | | | |
| EXAMINER | | • | | DATE CONSIDER | RED | | - | | | | |
| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | | | | | | | | | |

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO. MI22-1694 SERIAL NO. 09/885,393

LIST OF ART CITED BY APPLICANT
(Use several sheets if necessary)

APPLICANT Richard Holscher et al.

| JAN 1 3 200 | 4 2 33 | (Use several she | | FILING DATE June 19, 2001 | | | | GROUP 1756 | | | | | |
|----------------------|--------------------|-------------------------|---------------|---------------------------|------------------------|-------|----------------------|---------------|--------|--------|-------------------------------|--------|--|
| Dre mould | 84.6 | · | | U.S. PA | TENT DOCUMENTS | | , | | | | | | |
| *Examiner Initial | | Document Date Number | | | Name | | | Class Sul | | oclass | Filing Date If Appropriate | | |
| | AA | 6,133,618 | 10/00 | Steiner | | | | | | | | | |
| | AB | 5,994,217 | 11/99 | Ng | | | | | | | | | |
| | AC | 5,985,519 | 11/99 | Kakamu,e t al. | | | | | | | | | |
| | AD | 5,747,388 | 05/98 | Kusters, et al. | | | | | | | | | |
| | AE | 5,639,687 | 06/97 | Roman, et al. | | | | | | | | | |
| | AF | 5,498,555 | 03/96 | Lin | Lin Ohto Chang, et al. | | | | | | | | |
| | AG | 2001/0003064 | 06/01 | Ohto | | | | | | | | | |
| | АН | 2003/0013311 | 01/03 | Chang, e | | | | | | | | | |
| | Al | | | | | | | | | | | | |
| | AJ | | | | | | | | | | | | |
| | AK | | | | | | | | | | | | |
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| | | | | FOREIGN | PATENT DOCUMEN | NTS | | <u> </u> | | | | | |
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| | AO | | | | - | | | | | | | | |
| | AP | | | | | | | | | | | | |
| | | C | OTHER REFEREN | CES (includ | ing Author, Title, Dat | te, P | ertinent Pages, Etc. |) | | | | | |
| | AR | | | | | | | | | | | | |
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